

10A, 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Low voltage, high frequency, inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

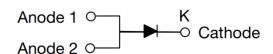
- Case: ThinDPAK
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.195g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
l _F	10	Α	
V_{RRM}	200	V	
I _{FSM}	200	Α	
T _{J MAX}	150	°C	
Package	ThinDPAK		
Configuration	Single die		





ThinDPAK



PARAMETER		SYMBOL	MBRAD10200H	UNIT
Marking code on the device			10200	
Repetitive peak reverse voltage		V _{RRM}	200	V
Reverse voltage, total rms value		V _R (RMS)	140	V
Forward current		lF	10	А
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	1	200	А
	t = 1.0ms	IFSM	480	А
Junction temperature	•	TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C



Taiwan Semiconductor

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance(1)	R _{OJL}	2.5	°C/W
Junction-to-ambient thermal resistance ⁽²⁾	Reja	13	°C/W
Junction-to-case thermal resistance ⁽²⁾	Rejc	2.9	°C/W

Notes:

- 1. With ideal heat sink
- 2. Units mounted on 2" x 3" x 0.25" Al-plate

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 5A, T _J = 25°C	VF	0.79	-	V
	I _F = 10A, T _J = 25°C		0.85	0.88	V
	I _F = 5A, T _J = 125°C		0.65	-	V
	I _F = 10A, T _J = 125°C		0.72	0.75	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	I _R	-	10	μA
	T _J = 125°C		-	2	mA
Junction capacitance	1MHz, V _R = 4.0V	Сл	145	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
MBRAD10200H	ThinDPAK	4,500 / Tape & Reel	



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

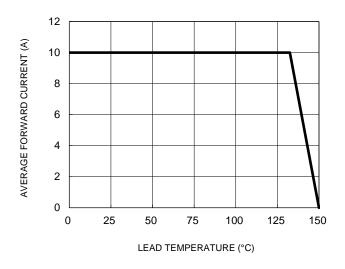


Fig.2 Typical Junction Capacitance

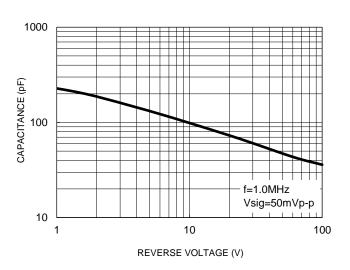
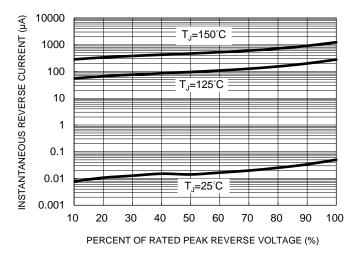


Fig.3 Typical Reverse Characteristics

Fig.4 Typical Forward Characteristics



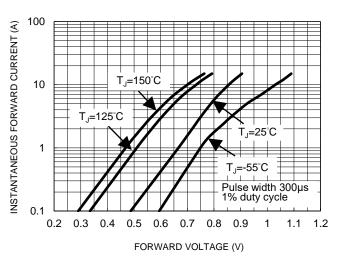
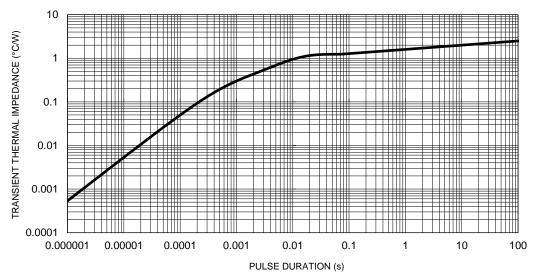


Fig.5 Typical Transient Thermal Impedance

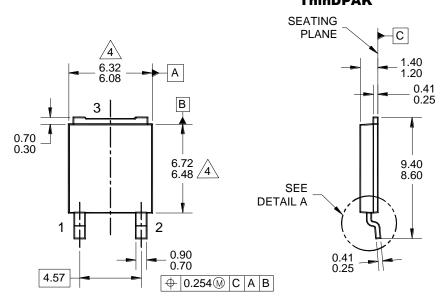


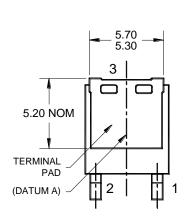
3

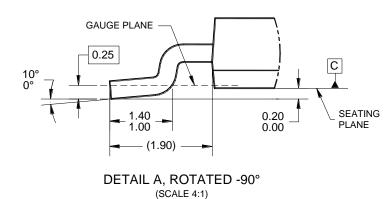


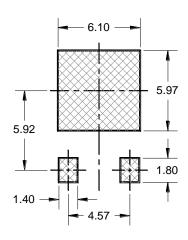
PACKAGE OUTLINE DIMENSIONS

ThinDPAK

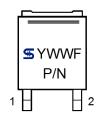








SUGGESTED PAD LAYOUT



MARKING DIAGRAM

YWW = DATE CODE F = FACTORY CODE

P/N = MARKING CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-252, VARIATION AE, ISSUE F.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURRS.
 - 5. DWG NO. REF: HQ2SD07-TDPAK-065 REV A.



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.